secured (e.g., glued into place). Midsection 316 fits around the top of base 302 and is rotationally aligned to be square with base 302. Upper base bearing 318 fits closely inside top section 320, and is rotationally aligned such that bearing slots 318a are aligned with top slots 320a, constituting constraint pin slots 300a. Top section 320 fits closely around the top of midsection 316 and is rotationally aligned to be square with midsection 316 and base 302.

[0051] Magnet 304 is preferably a high-strength permanent magnet. Base 302, flux disk 306 and midsection 316 are preferably made of a ferromagnetic material with good permeability (e.g., steel alloy 12L14). The top and sides of flux disk 306 are preferably painted black before assembly. Top section 320 is preferably made of a non-ferromagnetic material (e.g., 6110-T6 aluminum alloy). Upper base bearing 318 and lower base bearing 314 are preferably made of a low-friction material (e.g., PTFE). Proximity sensor 308 may be implemented using, for example, a reflective proximity sensor containing an LED (not shown) and a phototransistor (also not shown).

[0052] FIG. 4 illustrates an exploded perspective view of a haptel stationary assembly 300 mounted to a support plate 402. Support plate 402 is made of a rigid material with good heat conductivity, such as aluminum plate. It will be noted that FIG. 4 shows only a portion of support plate 402. Mounting hardware 404 may consist of two sets of machine screws, nuts and washers, for example. In one embodiment, the machine screws are routed through two diagonally opposite holes in haptel stationary assembly 300 and through support plate 402, and are fastened securely to the other side using nuts and washers. Position cable 310 is routed through a center hole in support plate 402. The hole pattern in support plate 402 should match the hole pattern in base 302.

[0053] FIG. 5A illustrates an exploded perspective view of the parts and assemblies of a haptel such as haptel 500. FIG. 5B illustrates a perspective view of haptel 500. Moving assembly 100 fits inside stationary assembly 300. Moving assembly 100 is preferably aligned such that constraint pin holes 100a are aligned within constraint pin slots 300a, making surface 102 of moving assembly 100 square with stationary assembly 300. Constraint pins 200 are glued into constraint pin holes 100a, fitting within, but not affixed to, constraint pin slots 200a. Coil cable 114 and XY cable 118 are routed through the remaining corner holes in stationary assembly 300 and support plate 402.

Grid description

[0054] FIG. 6A illustrates an exploded perspective view of the parts included in grid assembly 600. FIG. 6B illustrates a perspective view of grid assembly 600.

[0055] Unified support plate 602 is shown in FIG. 6A as having nine haptels (e.g., haptel 500) in a 3x3 grid configuration. Unified support plate 602 replaces support plate 402 for all haptels in the grid. The rectangularly arranged set of nine haptels is referred to as a haptel grid 604. The bolts, coil cables, position cables, and XY cables of all haptels go through appropriately positioned holes in unified support plate 602. In addition, there is a hole in the unified support plate beneath each base air hole 302b. Preferably, grid overlay 606 is affixed to haptel grid 604 at the centers of the haptel surfaces. Grid overlay 606 is a thin, slick, flexible and

stretchable material, such as .010"thick urethane elastomer sheet with 60 Shore A durometer hardness. Hand rest 608 is affixed to support plate 602 with grid feet 610. Hand rest 608 is preferably made of injection molded plastic, while grid feet 610 are preferably plastic with standard screws centrally embedded therein. The screws projecting from grid feet 610 preferably thread into holes in vertical supports 608a. The height of vertical supports 608a ensures that the upper surface of hand rest 608 is flush with the upper surface of haptel grid 604 when assembled.

System description

[0056] FIG. 9 illustrates a block diagram depicting the functional elements of an embodiment of the present invention. An input/output (I/O) device 900 includes haptels 500(1)-(N), position circuits 700(1)-(N), actuator circuits 800(1)-(N), XY interfaces 912(1)-(N) and a control system 902. Control system 902 includes an analog input card 906, two serial cards 910, a digital output card 908, and a control processor 904. Functional elements of haptels 500(1)-(N) are shown as a group containing magnet wires 108(1)-(N), proximity sensors 308(1)-(N) and XY sensors 116(1)-(N).

[0057] It will be noted that the variable identifier "N" is used in several instances in FIG. 9 to more simply designate the final element (e.g., haptel 500 (N), XY sensor 116(N), and so on) of a series of related or similar elements (e.g., haptels 500(1)-(N), XY sensor 116 (1)-(N), and so on). The repeated use of such variable identifiers is not meant to imply a correlation between the sizes of such series of elements, although such series may be equal in extent. The use of such variable identifiers does not require that each series of elements have the same number of elements as another series delimited by the same variable identifier. Rather, in each instance of use, the variable identified by "N" may hold the same or a different value than other instances of the same variable identifier. For example, haptel 500(N) may be the ninth in a series of haptels, whereas XY sensor 116(N) may be the forty-eighth XY sensor in a series of XY sensors. In the preferred embodiment, N equals nine for all series.

[0058] Each one of haptel proximity sensors 308(1)-(N) is coupled via a corresponding one of position cables 310(1)-(N) to a corresponding one of position circuits 700(1)-(N) as described in FIG. 7. The output of each one of position circuits 700(1)-(N) is coupled to an input of analog input card 906, which is installed in control system 902 and communicates with control processor 904 via a communications channel such as PCI bus 922. Analog input card 906 is preferably a high-speed data acquisition card with a number of inputs corresponding to the number of haptels in haptel grid 604 and may employ devices such as those available from National Instruments of Austin, Tex. under the trade designation PCI-6023E. Magnet wires 108(1)-(N) couple their respective haptel via one of coil cables 114 to the outputs of a respective one of actuator circuits 800(1)-(N), described in FIG. 8. The inputs of each of actuator circuits 800(1)-(N) are coupled to the outputs of digital output card 908 which is shared by actuator circuits 800(1)-(N). Digital output card 908 is installed in control system 902 and communicates with control processor 904 via a communications channel such as a device PCI bus 922. Digital output card 908 preferably provides at least 14 bits